



IPW
PATENT

Atty. Dkt. No. APPM/002622.D1(Y1)/PPC/ECP/CKIM

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Dordi, et al.

Serial No.: 10/630,185

Confirmation No.: 9224

Filed: July 29, 2003

For: Electro-Chemical
Deposition Cell For Face-
Up Processing Of Single
Semiconductor Substrates

MAIL STOP AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

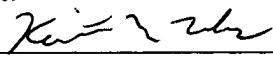
§ Group Art Unit: 1753

§ Examiner: Edna Wong

CERTIFICATE OF MAILING 37 CFR 1.8

I hereby certify that this correspondence is being deposited on
1/3, 2006 with the United States Postal Service as First
Class Mail in an envelope addressed to: Mail Stop
Amendment, Commissioner for Patents, P.O. Box 1450,
Alexandria, VA 22313-1450.

1/3/06
Date


Keith M. Tackett

RESPONSE TO OFFICE ACTION DATED OCTOBER 12, 2005

In response to the Office Action dated October 12, 2005, having a shortened statutory period for response set to expire on January 12, 2006, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/002622.D1(Y1)/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 5 of this paper.